

QUICKSWITCH® PRODUCTS 2.5V / 3.3V 20-BIT 2-PORT, HIGH BANDWIDTH BUS SWITCH

IDTQS3VH16210 PRELIMINARY

FEATURES:

- · N channel FET switches with no parasitic diode to Vcc
 - Isolation under power-off conditions
 - No DC path to Vcc or GND
 - 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Low Ron 4Ω typical
- · Flat Ron characteristics over operating range
- · Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- Excellent Ron matching between channels
- · Vcc operation: 2.3V to 3.6V
- · High bandwidth up to 500 MHz
- · LVTTL-compatible control Inputs
- · Undershoot Clamp Diodes on all switch and control Inputs
- · Low I/O capacitance, 4pF typical
- Available in SSOP and TSSOP packages

APPLICATIONS:

- · Hot-swapping
- · 10/100 Base-T, Ethernet LAN switch
- · Low distortion analog switch
- · Replaces mechanical relay
- ATM 25/155 switching

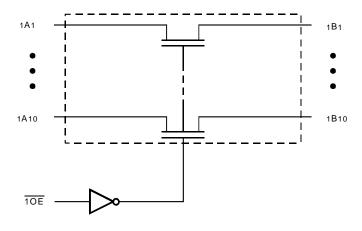
DESCRIPTION:

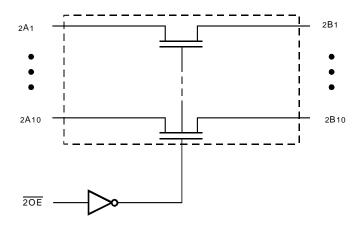
The QS3VH16210 HotSwitch with 20-bit flow-though pin is a high bandwidth bus switch. The QS3VH16210 has very low ON resistance, resulting in under 250ps propagation delay through the switch. The switches are controlled by active low enable (\overline{xOE}) controls. The QS3VH16210 is organized as a dual 10-bit, 2-port bus switch with separate, \overline{xOE} control inputs. In the OFF and ON states, the switches are 5V-tolerant. In the OFF state, the switches offer very high impedance at the terminals.

The combination of near-zero propagation delay, high OFF impedance, and over-voltage tolerance makes the QS3VH16210 ideal for high performance communications applications.

The QS3VH16210 is characterized for operation from -40°C to +85°C.

FUNCTIONAL BLOCK DIAGRAM

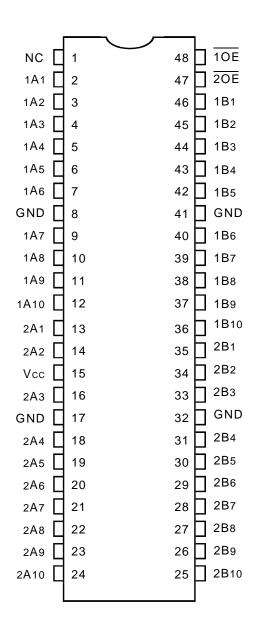




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MARCH 2002

PIN CONFIGURATION



SSOP/ TSSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Description	Max.	Unit
VTERM(2)	Supply Voltage to Ground	- 0.5 to 4.6	V
VTERM(3)	DC Switch Voltage Vs	- 0.5 to 5.5	V
VTERM(3)	DC Input Voltage VIN	- 0.5 to 5.5	V
VAC	AC Input Voltage (pulse width ≤20ns)	- 3	V
lout	DC Output Current (max. current/pin)	120	mA
Tstg	Storage Temperature	-65 to +150	°C

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may
 cause permanent damage to the device. This is a stress rating only and functional
 operation of the device at these or any other conditions above those indicated in the
 operational sections of this specification is not implied. Exposure to absolute
 maximum rating conditions for extended periods may affect reliability.
- 2. Vcc terminals.
- 3. All terminals except Vcc.

CAPACITANCE (TA = +25°C, f = 1MHz, VIN = 0V, VOUT = 0V)

Symbol	Parameter ⁽¹⁾	Тур.	Max.	Unit
CIN	Control Inputs	3	5	pF
CI/O	Quickswitch Channels (Switch OFF)	4	6	pF
CI/O	Quickswitch Channels (Switch ON)	8	12	pF

NOTE:

1. This parameter is guaranteed but not production tested.

PIN DESCRIPTION

Pin Names	Description
хОĒ	Bus Enables (Active LOW)
1A1 - 1A10, 2A1 - 2A10	Bus A
1B1 - 1B10, 2B1 - 2B10	Bus B

FUNCTION TABLE (EACH 10-BIT BUS SWITCH) (1)

Control Input xOE	Function	
L	A port = B port	
Н	Disconnect	

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

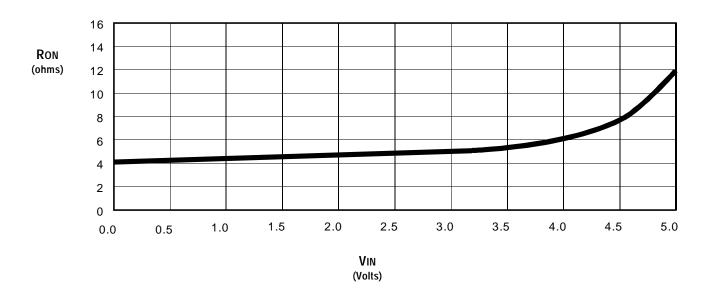
Industrial: TA = -40°C to +85°C, Vcc = 3.3V ± 0.3 V

Symbol	Parameter	Test Conditions			Min.	Typ. ⁽¹⁾	Max.	Unit
VIH	Input HIGH Voltage	Guaranteed Logic HI	Guaranteed Logic HIGH		1.7	_	_	V
		for Control Inputs		Vcc = 2.7V to 3.6V	2	_		
VIL	Input LOW Voltage	Guaranteed Logic HI	Guaranteed Logic HIGH \		_	_	0.7	V
		for Control Inputs		Vcc = 2.7V to 3.6V	_	_	0.8	
lin	Input Leakage Current (Control Inputs)	0V ≤ Vin ≤ Vcc		_	_	±1	μA	
loz	Off-State Current (Hi-Z)	0V ≤ Vouт ≤ 5V, Switches OFF			_	_	±1	μA
loff	Data Input/Output Power Off Leakage	VIN or VOUT 0V to 5V, VCC = 0V			_	±1	μA	
		Vcc = 2.3V	VIN = 0V	Ion = 30mA	_	6	8	
Ron	Switch ON Resistance	(Typ. at Vcc = 2.5V)	VIN = 1.7V	Ion = 15mA		7	9	Ω
		Vcc = 3V	VIN = 0V	Ion = 30mA	_	4	6	
			VIN = 2.4V	Ion = 15mA	_	5	8	

NOTE:

1. Typical values are at Vcc = 3.3V and TA = 25°C, unless otherwise noted.

TYPICAL ON RESISTANCE vs Vin AT Vcc = 3.3V



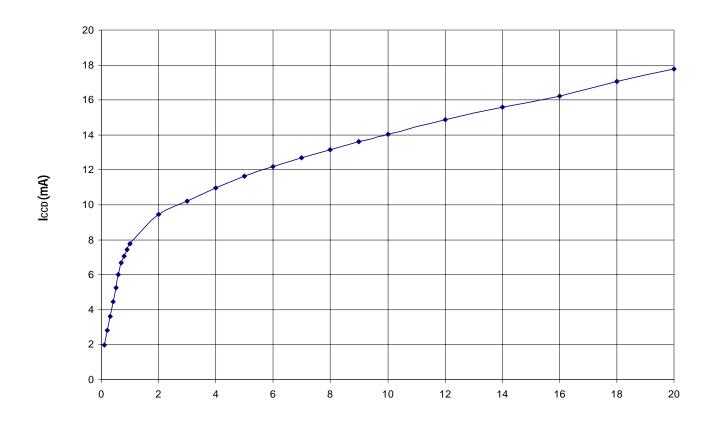
POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾	Min.	Тур.	Max.	Unit
Icco	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc, f = 0	_	1.5	3	mA
Δlcc	Power Supply Current ^(2,3) per Input HIGH	Vcc = Max., Vin = 3V, f = 0 per Control Input	_	_	30	μA
ICCD	Dynamic Power Supply Current ⁽⁴⁾	Vcc = 3.3V, A and B Pins Open, Control Inputs	See Typical I	ccd vs Enable	Frequency gra	ph below
		Toggling @ 50% Duty Cycle				

NOTES:

- 1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.
- 2. Per input driven at the specified level. A and B pins do not contribute to Δlcc.
- 3. This parameter is guaranteed but not tested.
- 4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

TYPICAL ICCD vs ENABLE FREQUENCY CURVE AT Vcc = 3.3V



ENABLE FREQUENCY (MHZ)

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

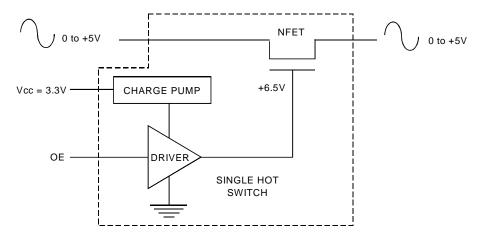
 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$

		$V_{CC} = 2.5 \pm 0.2V^{(1)}$		$Vcc = 3.3 \pm 0.3 V^{(1)}$		
Symbol	Parameter	Min. ⁽⁴⁾	Max.	Min. ⁽⁴⁾	Max.	Unit
tplH	Data Propagation Delay ^(2,3)	_	0.2	_	0.2	ns
t PHL	A to B or B to A					
tpzh	Switch Turn-On Delay	1.5	9	1.5	9	ns
tpzl	xBE to xA or xB					
tphz	Switch Turn-Off Delay	1.5	8.5	1.5	8.5	ns
tplz	xBE to xA or xB					
<u>fxOE</u>	Operating Frequency - Enable ^(2,5)	_	7.5	_	20	MHz

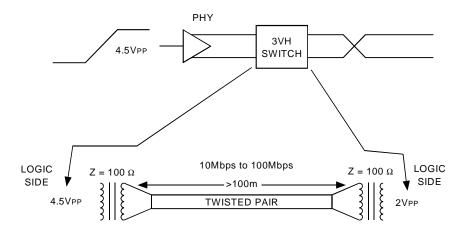
NOTES:

- 1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.
- 2. This parameter is guaranteed but not production tested.
- 3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.2ns at C_L = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.
- 4. Minimums are guaranteed but not production tested.
- 5. Maximum toggle frequency for $\overline{\text{xOE}}$ control input (pass voltage > Vcc, Vin = 5V, Rload \geq 1M Ω , no Cload).

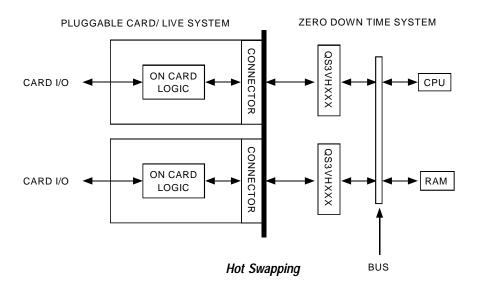
SOME APPLICATIONS FOR HOTSWITCH PRODUCTS



Rail-to-Rail Switching



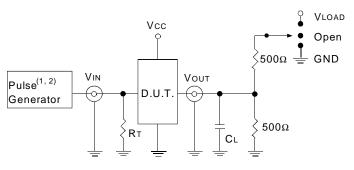
Fast Ethernet Data Switching (LAN Switch)



TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	Vcc ⁽¹⁾ = 3.3V ± 0.3V	Vcc ⁽²⁾ = 2.5V ± 0.2V	Unit
VLOAD	6	2 x Vcc	V
VIH	3	Vcc	V
VT	1.5	Vcc/2	V
VLZ	300	150	mV
VHZ	300	150	mV
CL	50	30	pF



Test Circuits for All Outputs

DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

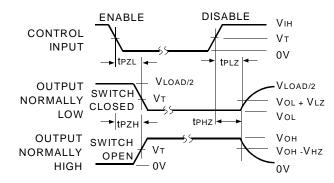
RT = Termination resistance: should be equal to ZouT of the Pulse Generator.

NOTES:

- 1. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tr \leq 2.5ns; tr \leq 2.5ns.
- 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tr \leq 2ns; tr \leq 2ns.

Vін SAME PHASE ۷т INPUT TRANSITION 0V tphl tplh Vон OUTPUT ۷т Vol tplh **t**PHL V_{IH} OPPOSITE PHASE ۷т INPUT TRANSITION 0٧

Propagation Delay



NOTE:

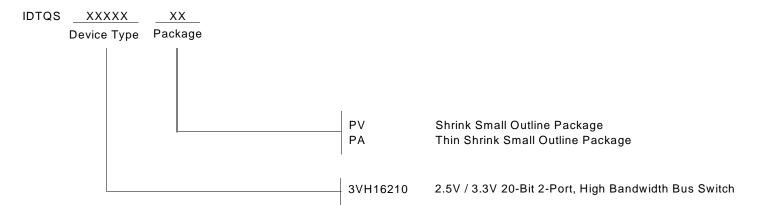
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Enable and Disable Times

SWITCH POSITION

Test	Switch
tplz/tpzl	Vload
tрнz/tpzн	GND
tpd	Open

ORDERING INFORMATION





2975 Stender Way Santa Clara, CA 95054 for SALES:

800-345-7015 or 408-727-6116 fax: 408-492-8674 www.idt.com

for Tech Support: logichelp@idt.com (408) 654-6459